

SGM7227 High Speed USB 2.0 (480Mbps) DPDT Analog Switch

GENERAL DESCRIPTION

The SGM7227 is a high-speed, low-power double-pole/double-throw (DPDT) analog switch that operates from a single 1.8V to 4.3V power supply.

SGM7227 is designed for the switching of high-speed USB 2.0 signals in handset and consumer applications, such as cell phones, digital cameras, and notebooks with hubs or controllers with limited USB I/Os.

The SGM7227 has low bit-to-bit skew and high channel-to-channel noise isolation, and is compatible with various standards, such as high-speed USB 2.0 (480 Mbps). Each switch is bidirectional and offers little or no attenuation of the high-speed signals at the outputs. Its bandwidth is wide enough to pass high-speed USB 2.0 differential signals (480 Mb/s) with good signal integrity.

The SGM7227 contains special circuitry on the D+/D-pins which allows the device to withstand a V_{BUS} short to D+ or D- when the USB devices are either powered off or powered on.

SGM7227 is available in Green UTQFN-1.8×1.4-10L and MSOP-10 packages. It operates over an ambient temperature range of -40°C to +85°C.

APPLICATIONS

Route Signals for USB 2.0
MP3 and Other Personal Media Players
Digital Cameras and Camcorders
Portable Instrumentation
Set-Top Box
PDAs

FEATURES

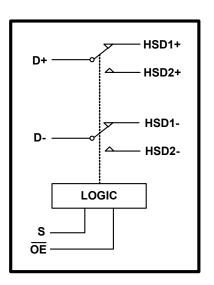
- R_{ON} is Typically 5Ω at 3.0V
- Voltage Operation: 1.8V to 4.3V
- Fast Switching Times:

ton 15ns

toff 20ns

- Crosstalk: -30dB at 250MHz
- Off-Isolation: -35dB at 250MHz
- Rail-to-Rail Input and Output Operation
- Break-Before-Make Switching
- Extended Industrial Temperature Range:
 -40°C to +85°C
- Available in Green UTQFN-1.8×1.4-10L and MSOP-10 Packages

BLOCK DIAGRAM



PACKAGE/ORDERING INFORMATION

| MODEL | PIN- PACKAGE | SPECIFIED TEMPERATURE RANGE | ORDERING NUMBER | PACKAGE MARKING | PACKAGE OPTION | |
|----------|-------------------|-----------------------------------|--------------------|--------------------|---------------------|--|
| 00147007 | MSOP-10 | -40℃ to +85℃ | SGM7227YMS10G/TR | SGM7227YMS10 | Tape and Reel, 3000 | |
| SGM7227 | UTQFN-1.8×1.4-10L | -40℃ to +85℃ | SGM7227YUWQ10G/TR | 7227 | Tape and Reel, 3000 | |

ABSOLUTE MAXIMUM RATINGS

| V _{CC} to GND | 0V to 4.6V |
|-----------------------------------|-----------------------------------|
| Analog, Digital voltage range | 0.3V to (V _{CC}) + 0.3V |
| Continuous Current HSDn or Dn | ±50mA |
| Peak Current HSDn or Dn | ±100mA |
| Operating Temperature Range | 40°C to +85°C |
| Junction Temperature | 150°C |
| Storage Temperature Range | 65°C to +150°C |
| Lead Temperature (Soldering, 10s) | 260°C |
| ESD Susceptibility | |
| HBM | 8000V |
| MM | 400V |

NOTE:

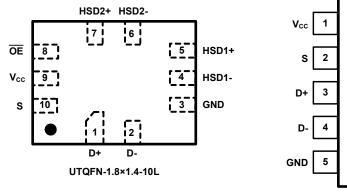
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

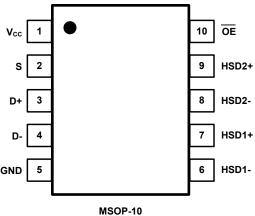
CAUTION

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

SGMICRO reserves the right to make any change in circuit design, specification or other related things if necessary without notice at any time. Please contact SGMICRO sales office to get the latest datasheet.

PIN CONFIGURATIONS (TOP VIEW)





PIN DESCRIPTION

| PIN | | | - Incorpora | | |
|-------------------|---------|-----------------|---------------------------|--|--|
| UTQFN-1.8×1.4-10L | MSOP-10 | NAME | FUNCTION | | |
| 9 | 1 | V _{CC} | Power Supply | | |
| 3 | 5 | GND | Ground | | |
| 10 | 2 | S | Select Input | | |
| 8 | 10 | ŌĒ | Output Enable | | |
| 5 | 7 | HSD1+ | Multiplexed Source Inputs | | |
| 4 | 6 | HSD1- | Multiplexed Source Inputs | | |
| 7 | 9 | HSD2+ | Multiplexed Source Inputs | | |
| 6 | 8 | HSD2- | Multiplexed Source Inputs | | |
| 1 | 3 | D+ | USB Data Bus | | |
| 2 | 4 | D- | USB Data Bus | | |

FUNCTION TABLE

| ŌE | s | HSD1+, HSD1- | HSD2+, HSD2- |
|----|---|--------------|--------------|
| 0 | 0 | ON | OFF |
| 0 | 1 | OFF | ON |
| 1 | × | OFF | OFF |

Switches Shown For Logic "0" Input

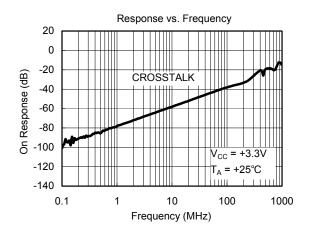
SGM7227

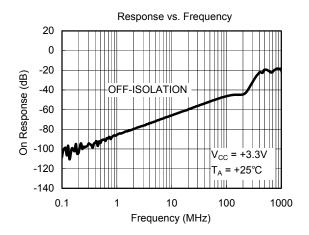
ELECTRICAL CHARACTERISTICS

(V_{CC} = +3.3V, T_A = +25°C, unless otherwise noted.)

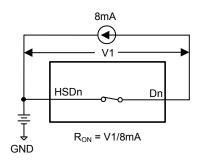
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|--|--|---|-----|-----|-----------------|-------|
| ANALOG SWITCH | | | | | | |
| Analog I/O Voltage (HSD1+, HSD1-, HSD2+, HSD2-) | V _{IS} | | 0 | | V _{CC} | V |
| On-Resistance | R _{ON} | V_{CC} = 3.0V, V_{IS} = 0V to 0.4V, I_D = 8mA, Test Circuit 1 | | 5 | 9 | Ω |
| On-Resistance Match Between Channels | ΔR_{ON} | V_{CC} = 3.0V, V_{IS} = 0V to 0.4V, I_D = 8mA, Test Circuit 1 | | 0.3 | 0.8 | Ω |
| On-Resistance Flatness | $R_{FLAT(ON)}$ | V_{CC} = 3.0V, V_{IS} = 0V to 1.0V, I_D = 8mA, Test Circuit 1 | | 1 | 2 | Ω |
| Power Off Leakage Current (D+, D-) | I _{OFF} | $V_{CC} = 0V, V_D = 0V \text{ to } 3.6V, V_S, V_{\overline{OE}} = 0V \text{ or } 3.6 \text{ V}$ | | | 1 | μА |
| Increase in I _{CC} per Control Voltage | I _{CCT} | $V_{CC} = 3.6V$, V_S or $V_{\overline{OE}} = 2.6V$ | | | 5 | μΑ |
| Source Off Leakage Current | I _{HSD2(OFF)} , I _{HSD1(OFF)} | V _{CC} = 3.6V, V _{IS} = 3.3V/ 0.3V, V _D = 0.3V/ 3.3V | | | 1 | μA |
| Channel On Leakage Current | I _{HSD2(ON)} , I _{HSD1(ON)} | $V_{CC} = 3.6V$, $V_{IS} = 3.3V/0.3V$, $V_{D} = 3.3V/0.3V$ or floating | | | 1 | μΑ |
| DIGITAL INPUTS | | | | | | |
| Input High Voltage | V_{IH} | | 1.6 | | | V |
| Input Low Voltage | V _{IL} | | | | 0.5 | V |
| Input Leakage Current | I _{IN} | $V_{CC} = 3.0V$, V_S , $V_{\overline{OE}} = 0V$ or V_{CC} | | | 1 | μΑ |
| DYNAMIC CHARACTERISTICS | | | | | | |
| Turn-On Time | t _{ON} | $V_{IS} = 0.8V, R_L = 50\Omega, C_L = 10pF,$ | | 15 | | ns |
| Turn-Off Time | t _{OFF} | Test Circuit 2 | | 20 | | ns |
| Break-Before-Make Time Delay | t _D | V_{IS} = 0.8V, R_L = 50 Ω , C_L = 10pF, Test Circuit 3 | | 3.5 | | ns |
| Propagation Delay | t_{PD} | $R_L = 50\Omega$, $C_L = 10pF$ | | 0.5 | | ns |
| Off Isolation | O _{ISO} | Signal = 0dBm, R_L = 50 Ω , f = 250MHz, Test Circuit 4 | | -35 | | dB |
| Channel-to-Channel Crosstalk | X _{TALK} | Signal = 0dBm, R_L = 50 Ω , f = 250MHz, Test Circuit 5 | | -30 | | dB |
| –3dB Bandwidth | BW | Signal = 0dBm, $R_L = 50\Omega$, $C_L = 5pF$, Test Circuit 6 | | 550 | | MHz |
| Channel-to-Channel Skew | t _{SKEW} | $R_L = 50\Omega$, $C_L = 10pF$ | | 130 | | ps |
| Charge Injection Select Input to Common I/O | Q | V_G = GND, C_L = 1.0nF, R_G = 0 Ω , Q = C_L × V_{OUT} , Test Circuit 7 | | 10 | | рС |
| HSD+, HSD-, D+, D- | C _{ON} | f = 1MHz | | 6.5 | 6.5 | |
| ON Capacitance | | f = 250MHz | | 7 | | - pF |
| POWER REQUIREMENTS | | | | | | |
| Power Supply Range | V _{CC} | | 1.8 | | 4.3 | V |
| | | | | | | |

TYPICAL PERFORMANCE CHARACTERISTICS

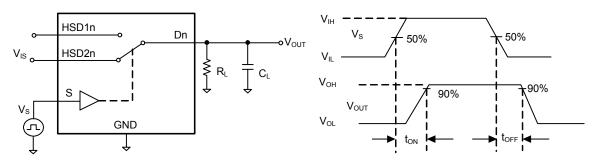




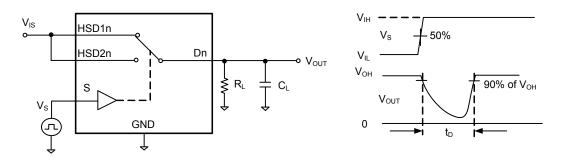
TEST CIRCUITS



Test Circuit 1. On Resistance

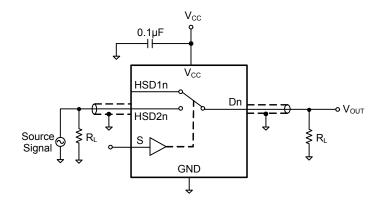


Test Circuit 2. Switching Times (t_{ON} , t_{OFF})

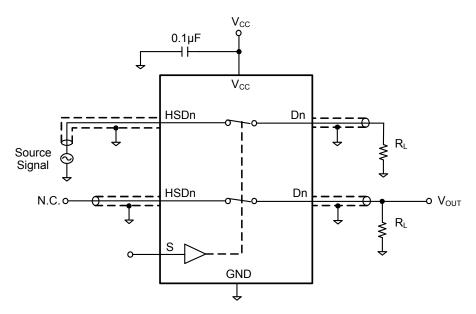


Test Circuit 3. Break-Before-Make Time (t_D)

TEST CIRCUITS (Cont.)



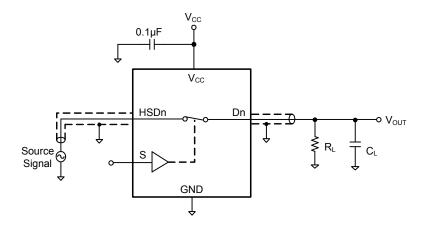
Test Circuit 4. Off Isolation



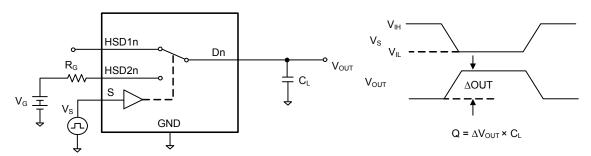
Channel To Channel Crosstalk = -20 \times log $\frac{V_{HSDn}}{V_{OUT}}$

Test Circuit 5. Channel-to-Channel Crosstalk

TEST CIRCUITS (Cont.)



Test Circuit 6. -3dB Bandwidth



Test Circuit 7. Charge Injection (Q)

SGM7227

APPLICATION NOTES

Meeting USB 2.0 V_{BUS} Short Requirements

Power-Off Protection

For a V_{BUS} short circuit the switch is expected to withstand such a condition for at least 24 hours. The SGM7227 has specially designed circuitry which prevents unintended signal bleed through as well as guaranteed system reliability during a power-down, over-voltage condition. The protection has been added to the common pins (D+, D-).

Power-On Protection

The USB 2.0 specification also notes that the USB device should be capable of withstanding a V_{BUS} short during transmission of data. This modification works by limiting current flow back into the V_{CC} rail during the over-voltage event so current remains within the safe operating range.

SGM7227 USB2.0 Signal Quality Compliance Test Results

Figures 1 and 2 show the test results for USB eye diagram tests.

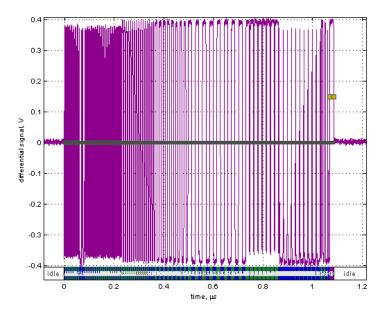


Figure 1. Waveform Plot

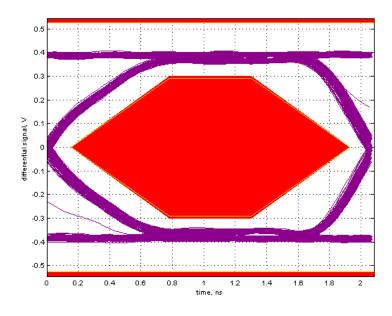


Figure 2. High Speed Signal Quality Eye Diagram Test ($V_{CC} = 3.3V$)

High Speed USB 2.0 (480Mbps) DPDT Analog Switch

SGM7227

The following is a summary of the USB test Results. The SGM7227 passes the high speed signal quality, eye diagram and jitter tests.

Required Tests

- Overall result:
 - Pass!
- Signal eye:
 - Eye passes
- EOP width: 7.91 bits
 EOP width passes
- Measured signaling rate: 480.0551MHz
 - Signal rate passes
- Rising Edge Rate: 901.28V/µs (710.10ps equivalent rise-time)
 - **Passes**
- Falling Edge Rate: 889.18V/µs (719.77ps equivalent rise-time)

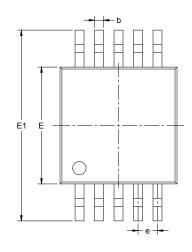
Passes

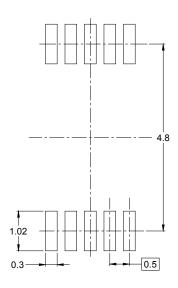
Additional Information

Consecutive jitter range: -61.770ps to 39.668ps, RMS jitter 21.900ps Paired JK jitter range: -47.800ps to 42.890ps, RMS jitter 21.591ps Paired KJ jitter range: -50.590ps to 49.704ps, RMS jitter 23.281ps

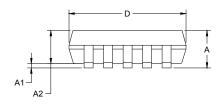
PACKAGE OUTLINE DIMENSIONS

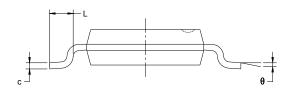
MSOP-10





RECOMMENDED LAND PATTERN (Unit: mm)

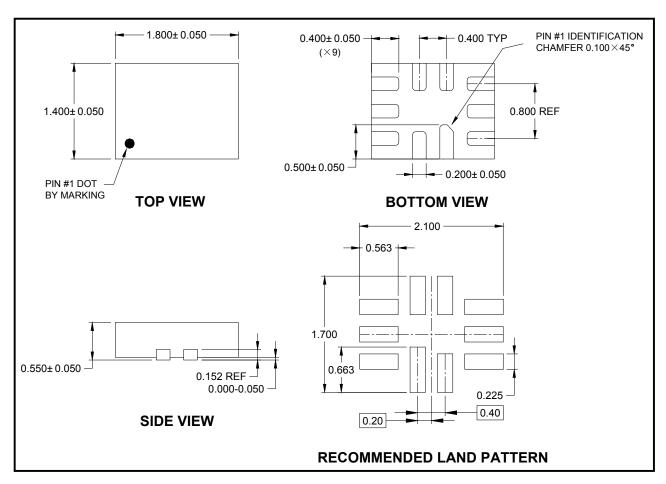




| Symbol | _ | nsions imeters | Dimensions In Inches | | | |
|--------|-------|-------------------|-------------------------|-------|--|--|
| | MIN | MAX | MIN | MAX | | |
| А | 0.820 | 1.100 | 0.032 | 0.043 | | |
| A1 | 0.020 | 0.150 | 0.001 | 0.006 | | |
| A2 | 0.750 | 0.950 | 0.030 | 0.037 | | |
| b | 0.180 | 0.280 | 0.007 | 0.011 | | |
| С | 0.090 | 0.230 | 0.004 | 0.009 | | |
| D | 2.900 | 0 3.100 0.114 | | 0.122 | | |
| Е | 2.900 | 3.100 | 0.114 | 0.122 | | |
| E1 | 4.750 | 5.050 | 0.187 | 0.199 | | |
| е | 0.500 | BSC | 0.020 | BSC | | |
| L | 0.400 | 0.800 | 0.016 | 0.031 | | |
| θ | 0° 6° | | 0° | 6° | | |

PACKAGE OUTLINE DIMENSIONS

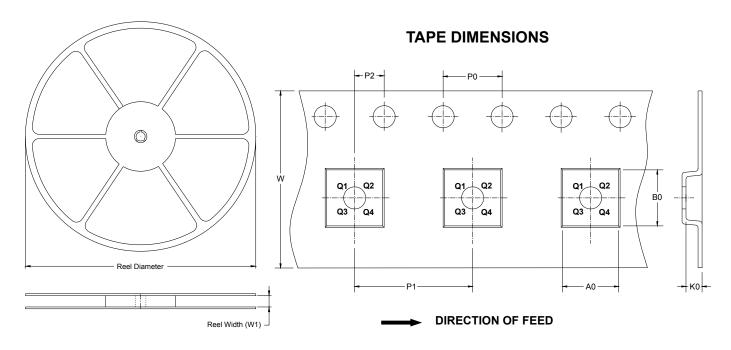
UTQFN-1.8×1.4-10L



NOTE: All linear dimensions are in millimeters.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

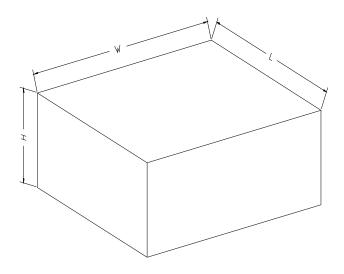


NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

| Package Type | Reel Diameter | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P0 (mm) | P1 (mm) | P2 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|---------------|--------------------------|------------|------------|------------|------------|------------|------------|-----------|------------------|
| UTQFN-1.8×1.4-10L | 7" | 9.0 | 1.75 | 2.10 | 0.70 | 4.00 | 4.00 | 2.00 | 8.00 | Q1 |
| MSOP-10 | 13" | 12.4 | 5.2 | 3.3 | 1.2 | 4.0 | 8.0 | 2.0 | 12.0 | Q1 |

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

| Reel Type | Reel Type Length (mm) Width (mm) | | Height (mm) | Pizza/Carton | |
|-------------|----------------------------------|-----|----------------|--------------|--|
| 7" (Option) | 368 | 227 | 224 | 8 | |
| 7" | 442 | 410 | 224 | 18 | |
| 13" | 386 | 280 | 370 | 5 | |